No.: RMCH-K-HTS-0001 /5

Date: 2023.1.11

# Data sheet

Title: FIXED THICK FILM CHIP RESISTORS;

**RECTANGULAR TYPE & HIGH POWER** 

Style: RMCH10,16,20,32,35

# RoHS COMPLIANCE ITEM Halogen and Antimony Free

Note: •Stock conditions

Temperature:  $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity:  $25\% \sim 75\%$ 

The period of guarantee: Within 2 year from shipment by the company. Solderability shall be satisfied.

- •Product specification contained in this data sheet are subject to change at any time without notice
- •If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

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#### 1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & high power, style of RMCH10,16,20,32,35.

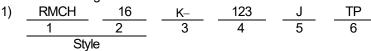
#### 1.2 Applicable documents

JIS C 5201–1: 2011, JIS C 5201–8: 2014, JIS C 5201–8–1: 2014 IEC60115–1: 2008, IEC60115–8: 2009, IEC60115–8–1: 2014 EIAJ RC-2134C-2010

#### 2. Classification

Type designation shall be the following form.

(Example)



1 Fixed thick film chip resistors; rectangular type & high power

\_\_\_\_\_\_ Style

2 Rated dissipation and / or dimension

3 Temperature coefficient of resistance

K	±100×10 <sup>-6</sup> / °C
–(Dash)	Standard

# 4 Rated resistance

123	E24 Series, 3 digit,	Ex. 123> 12kΩ,
1000	E96 Series, 4 digit,	Ex. 1000>100Ω
		1022> 10.2kΩ

# 5 Tolerance on rated resistance

D	±0.5%
F	±1%
J	±5%

# 6 Packaging form

В	Bulk (loose package)	
TH	Paper taping	
TP		
TE	Embossed taping	



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#### 3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)		ture coefficient of nce (10 <sup>6</sup> / °C)	Rated resistance range (Ω)	Preferred number series for resistors	Tolerance on rated resistance
		K	±100	10~1M	E24, 96	D(+0.50/.) E(+10/.)
RMCH10	0.125	Standard	±200	1~9.76	⊏24, 90	D(±0.5%),F(±1%)
RIVICHIU	0.125	K	±100	10~1M	E24	1/+50/>
		Standard	±200	1~9.1	□ □ □ □	J(±5%)
		K	±100	10~1M	E24, 96	D(+0.50/.) E(+40/.)
RMCH16	0.25	Standard	±200	1~9.76	⊏24, 90	D(±0.5%),F(±1%)
RIVICHIO	0.25	K	±100	10~1M	E24	1/+50/>
		Standard	±200	1~9.1		J(±5%)
		K	±100	10~1M	E24, 96	D(±0.5%),F(±1%)
RMCH20	0.4	Standard	±200	1~9.76		
RIVICHZU	0.4	K	±100	10~1M	E24	I/± <b>E</b> 0/.)
		Standard	±200	1~9.1	⊏24	J(±5%)
		K	±100	10~1M	E24, 96	D(±0.50/.) E(±10/.)
RMCH32	0.5	Standard	±200	1~9.76	Ľ24, 90	D(±0.5%),F(±1%)
RIVICHSZ	0.5	K	±100	10~1M	F04	1/+50/>
		Standard	±200	1~9.1	E24	J(±5%)
		K	±100	10~1M	E24, 96	D(±0 5%) E(±1%)
RMCH35	0.75	Standard	±200	1~9.76	⊏∠4, 90	D(±0.5%),F(±1%)
KIVICHOO		K	±200	10~1M	E04	1/+50/)
		Standard	±200	1~9.1	E24	J(±5%)

Stylo	Limiting element	Insulation voltage	Category temperature
Style	voltage (V)	(V)	range (°C)
RMCH10	50	100	
RMCH16	150	150	
RMCH20			<i>–</i> 55∼+155
RMCH32	200	500	
RMCH35			

3.2 Climatic category

55/155/56 Lower category temperature -55°C Upper category temperature +155 °C

> Duration of the damp heat, steady state test 56days

3.3 Stability class

2% Limits for change of resistance:

> -for long-term tests  $\pm (2\% + 0.1\Omega)$  $\pm (0.5\% + 0.05\Omega)$ -for short-term tests

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#### 3.4 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

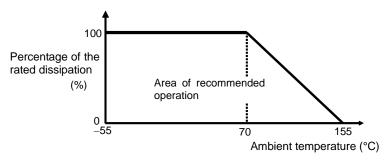


Figure-1 Derating curve

#### 3.5 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

E : Rated voltage (V)

E = 
$$\bigvee$$
 P · R

P : Rated dissipation (W)

R : Rated resistance ( $\Omega$ )

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

#### 4. Packaging form

The standard packaging form shall be in accordance with Table-2.

Table-2

=					
Symbol Packaging form		Standard packaging quantity / units	Application		
В	Bulk (loose package)		1,000 pcs.	RMCH10,16,20,32,35	
TH	Paper taping	8mm width, 2mm pitches	10,000 pcs.	RMCH10	
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RMCH16,20,32	
TE	Embossed taping	8mm width, 4mm pitches	4,000 pcs.	RMCH35	

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#### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure–2 and Table–3.

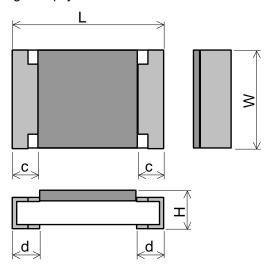


Figure-2

Table-3					Unit: mm
Style	L	W	Н	С	d
RMCH10	1.0±0.05	0.5±0.05	0.35±0.05	0.2±0.15	$0.25^{+0.05}_{-0.10}$
RMCH16	1.6±0.1	0.8 +0.15 -0.05	0.45±0.10	0.3±0.2	0.3±0.1
RMCH20	2.0±0.1	1.25±0.10	0.55±0.10	0.3±0.2	0.4±0.2
RMCH32	3.1±0.1	1.6±0.15	0.55±0.10	0.3±0.2	0.5±0.25
RMCH35	3.1±0.15	2.5±0.15	0.55±0.15	0.3±0.2	0.5±0.25

## 5.2 Net weight (Reference)

J (	,
Style	Net weight(mg)
RMCH10	0.6
RMCH16	2
RMCH20	5
RMCH32	9
RMCH35	16

#### 6. Marking

The nominal resistance shall be marked in 3 digits or 4 digits and marked on over coat side.

• E24 series: 3 digits, E96 series: 4 digits

In case of the resistance value that E96 overlaps with E24, It is marked by either.

The Rated resistance of RMCH10 should not be marked.

The Rated resistance of RMCH16 should not be marked in 4 digits (E96).

Marking example	Contents	Application
123	12×10 <sup>3</sup> $[\Omega] \rightarrow$ 12 $[k\Omega]$	RMCH16,20,32,35
2R2	2.2 [Ω]	Less than 10Ω of RMCH16,20,32,35
5623	$562\times10^{3} [\Omega] \rightarrow 562[k\Omega]$	RMCH20,32,35
12R7	12.7 [Ω]	RMCH20,32,35



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#### 7. Performance

7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201–1:2011.

7.2 The performance shall be satisfied in Table-4.

Table-4(1)

No.	Test items	Condition of test (JIS C 5201–1)	Performance requirements
1	Visual examination	Sub-clause 4.4.1	As in 4.4.1
-		Checked by visual examination.	The marking shall be legible, as
		,	checked by visual examination.
2	Dimension	Sub-clause 4.4.2	As specified in Table-3 of this
			specification.
	Resistance	Sub-clause 4.5	As in 4.5.2
			The resistance value shall
			correspond with the rated resistance taking into account the specified
			tolerance.
3	Voltage proof	Sub-clause 4.7	tolorarios.
	3 1	Method: 4.6.1.4	No breakdown or flash over
		Test voltage: Alternating voltage with a peak	
		value of 1.42 times the insulation	
		voltage.	
		Duration: 60 s ± 5 s	D: 400
		Insulation resistance Test voltage: Insulation voltage	R≥1GΩ
		Duration: 1 min.	
4	Solderability	Sub-clause 4.17	As in 4.17.4.5
	Coluciasiii	Without ageing	The terminations shall be covered
		Flux: The resistors shall be immersed in a	with a smooth and bright solder
		non–activated soldering flux for 2s.	coating.
		Bath temperature: 235 °C ± 5 °C	
		Immersion time: 2 s ± 0.5 s	
5	Mounting	Sub-clause 4.31	
	Overload	Substrate material: Epoxide woven glass	
	(in the mounted state)	Sub-clause 4.13	
	(iii tile filodilited state)	The applied voltage shall be 2.5 times the rated voltage or twice the limiting element	
		voltage, whichever is the less severe.	
		Duration: 2 s	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (1\% + 0.05\Omega)$
	Solvent resistance of the	Sub-clause 4.30	Legible marking
	marking	Solvent: 2-propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 1	
		Rubbing material: cotton wool Without recovery	
		v viu lout recovery	



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Table-4(2)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
6	Mounting	Sub-clause 4.31	·
	_	Substrate material: Epoxide woven glass	
	Bound strength of the end face	Sub-clause 4.33	
	plating	Bent value: 3 mm (3225 size max.)	
	Final measurements	Resistance	$\Delta R \le \pm (0.5\% + 0.05\Omega)$
		Sub-clause 4.33.6	No visible damage
		Visual examination	
7	Resistance to soldering heat	Sub-clause 4.18	
		Solder temperature: 260 °C ± 5 °C	
		Immersion time: 10 s ± 0.5 s	
		Visual examination	As in 4.18.3.4
			No sign of damage such as cracks.
		Resistance	$\Delta R \le \pm (0.5\% + 0.05\Omega)$
	Component solvent resistance	Sub-clause 4.29	
		Solvent: 2-propanol	
		Solvent temperature: 23 °C ± 5 °C	
		Method 2	
		Recovery: 48 h	No visible demons
		Visual examination	No visible damage
	NA	Resistance	$\Delta R \le \pm (0.5\% + 0.05\Omega)$
8	Mounting	Sub-clause 4.31	
	Adhesion	Substrate material: Epoxide woven glass	
	Adriesion	Sub-clause 4.32	
		Force: 5 N	
		Duration: 10 s ± 1 s Visual examination	No visible damage
	Rapid change temperature	Sub-clause 4.19	TWO VISIBLE GATTAGE
	rapid drange temperatare		
		Lower category temperature: –55 °C Upper category temperature: +155 °C	
		Duration of exposure at each temperature: 30	
		min.	
		Number of cycles: 5 cycles.	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (0.5\% + 0.05\Omega)$

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Table-4(3)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
9	Climatic sequence	Sub-clause 4.23	·
	-Dry heat	Sub-clause 4.23.2	
	, and the second se	Test temperature: +155 °C	
		Duration: 16 h	
		Sub-clause 4.23.3	
		Test method: 2	
		Test temperature: 55 °C	
	–Damp heat, cycle	[Severity(2)]	
	(12+12hour cycle)	Sub-clause 4.23.4	
	First cycle	Test temperature –55 °C	
		Duration: 2h	
	-Cold	Sub-clause 4.23.6	
		Test method: 2	
		Test temperature: 55 °C	
	–Damp heat, cycle	[Severity (2)]	
	(12+12hour cycle)	Number of cycles: 5 cycles	
	Remaining cycle	Sub-clause 4.23.7	
		The applied voltage shall be the rated voltage	
	D.O. Israel	or the limiting element voltage whichever is the	
	–D.C. load	smaller.	
		Duration: 1 min.	No visible damage
		Visual examination	$\Delta R \le \pm (2\% + 0.1\Omega)$
10	Marriage	Resistance	
10	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Endurance at 70 °C	Sub-clause 4.25.1	
		Ambient temperature: 70 °C ± 2 °C	
		Duration: 1000 h	
		The voltage shall be applied in cycles of 1.5 h	
		on and 0.5 h off.	
		The applied voltage shall be the rated voltage	
		or the limiting element voltage whichever is the	
		smaller.	
		Examination at 48 h, 500 h and	
		1000 h:	
		Visual examination	No visible damage
		Resistance	$\Delta R \le \pm (2\% + 0.1\Omega)$
11	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Variation of resistance with	Sub-clause 4.8	As in Table–1
	temperature	–55 °C / +20 °C	
		+20 °C / +155°C	



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Table-4(4)

No	Test items	Condition of test (JIS C 5201–1)	Performance requirements
12	Mounting	Sub-clause 4.31	
		Substrate material: Epoxide woven glass	
	Damp heat, steady state	Sub-clause 4.24	
		Ambient temperature: 40 °C ± 2 °C	
		Relative humidity: 93 +2 %	
		a) 1st group: without voltage applied.	
		b) 2nd group: The d. c. voltage shall be applied	
		continuously.	
		The voltage shall be accordance with	
		Sub-clause 4.24.2.1 b). without polarizing	
		voltage [4.24.2.1, c)]	No. 229 Landau and
		Visual examination	No visible damage
			Legible marking
		Resistance	$\Delta R \le \pm (2\% + 0.1\Omega)$
13	Dimensions (detail)	Sub-clause 4.4.3	As in Table–3
	Mounting Sub-clause 4.31		
	F., d	Substrate material: Epoxide woven glass	
	Endurance at upper category	Sub-clause 4.25.3	
	temperature	Ambient temperature:155 °C ± 2 °C	
		Duration: 1000 h	
		Examination at 48 h, 500 h and	
		1000 h:	No visible demons
		Visual examination	No visible damage
		l Resistance	$\Delta R \leq \pm (2\% + 0.1\Omega)$

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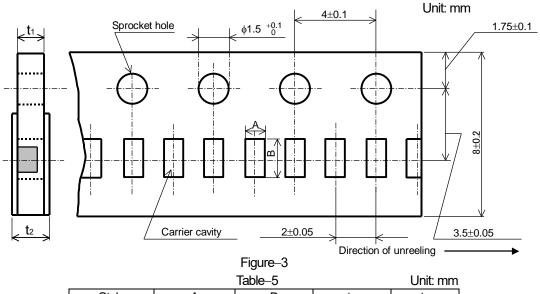
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## 8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Paper taping (8mm width, 2mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.



#### 8.2.2 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-4 and Table-6.

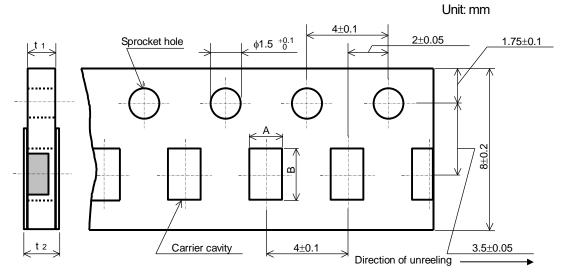


Figure 4

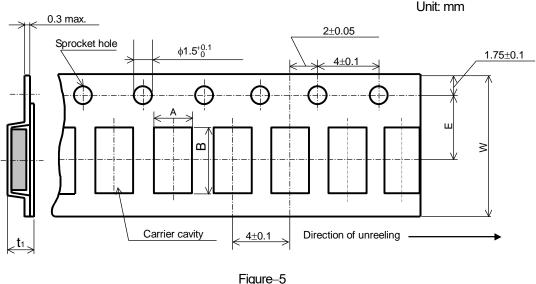
	Unit: mm			
Style	Α	В	<b>t</b> 1	t 2
RMCH16	1.15 ± 0.15	1.9 ± 0.2	$0.6 \pm 0.1$	0.8max.
RMCH20	1.65±0.15	2.5±0.2	0.8±0.1	1.0max.
RMCH32	2.00±0.15	3.6±0.2		

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8.2.3 Embossed taping dimensions shall be in accordance with Figure-5 and Table-7.



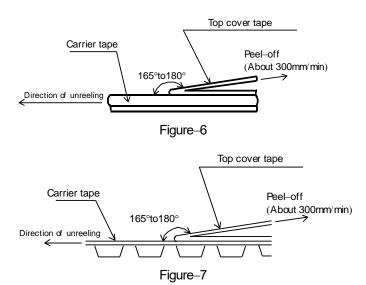
 Figure—5

 Table—7
 Unit: mm

 Style
 A
 B
 W
 E
 t 1

 RMCH35
 2.85±0.20
 3.5±0.2
 8.0±0.3
 3.5±0.05
 1.0±0.2

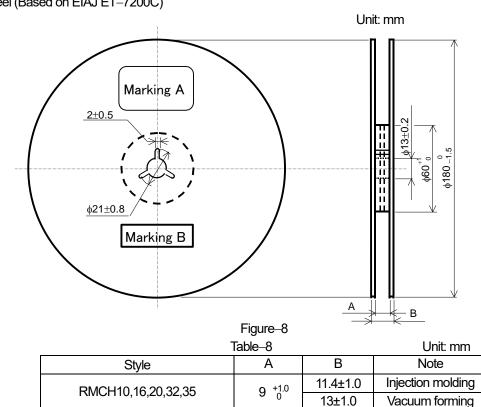
- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RMCH10,16,20,32: Figure-6, RMCH35: Figure-7.
- 6). When the tape is bent with the minimum radius for 25 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- In no case shall there be two or more consecutive components missing.
   The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



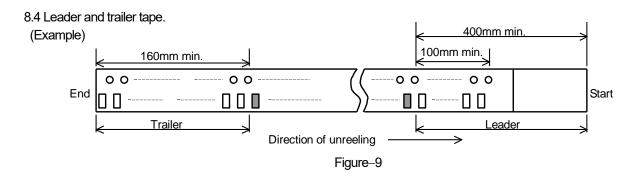
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#### 8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure-8 and Table-8. Plastic reel (Based on EIAJ ET-7200C)



Note: Marking label shall be marked on a place of Marking A or two place of marking A and B.



#### 9. Marking on package

The label of a minimum package shall be legibly marked with follows.

#### 9.1 Marking A

(1) Classification

(Style, Temperature coefficient of resistance, Rated resistance, Tolerance on rated resistance, Packaging form)

(2) Quantity (3) Lot number (4) Manufacturer's name or trade mark

9.2 Marking B (KAMAYA Control label)